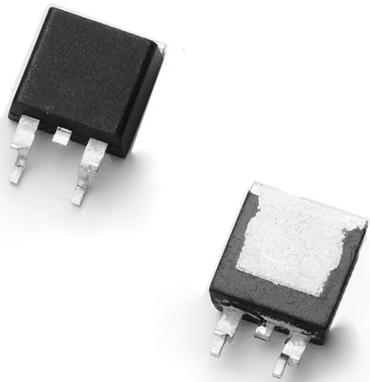
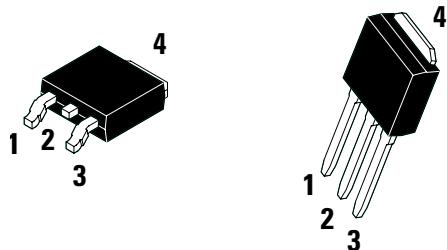


MAC4DCM, MAC4DCN**Description**

The MAC4DCM and MAC4DCN are designed for high volume, low cost, industrial and consumer applications such as motor control; process control; temperature, light and speed control.

Features

- Small Size Surface Mount DPAK Package
- Passivated Die for Reliability and Uniformity
- Blocking Voltage to 800 V
- On-State Current Rating of 4.0 A RMS at 108°C
- High Immunity to dv/dt – 500 V/μs at 125°C
- High Immunity to di/dt – 6.0 A/ms at 125°C
- Epoxy Meets UL 94 V-0 @ 0.125 in
- ESD Ratings: Human Body Model, 3B > 8000V Machine Model, C > 400V
- Lead-free Packages are Available

Pin Out**Functional Diagram**

Thyristors

Surface Mount – 600V - 800V > MAC4DCM, MAC4DCN

Maximum Ratings ($T_J = 25^\circ\text{C}$ unless otherwise noted)

Rating	Symbol	Value	Unit
Peak Repetitive Off-State Voltage (Note 1) (Gate Open, Sine Wave 50 to 60 Hz, $T_J = -40^\circ\text{C}$ to 125°C)	$V_{DRM'}$ V_{RRM}	600 800	V
On-State RMS Current (Full Cycle Sine Wave, 60 Hz, $T_c = 108^\circ\text{C}$)	$I_T (\text{RMS})$	4.0	A
Peak Non-Repetitive Surge Current (One Full Cycle Sine Wave, 60 Hz, $T_c = 125^\circ\text{C}$)	I_{TSM}	40	A
Circuit Fusing Consideration ($t = 8.3 \text{ msec}$)	I^2t	6.6	A^2sec
Peak Gate Current (Pulse Width $\leq 20 \mu\text{sec}$, $T_c = 108^\circ\text{C}$)	I_{GM}	4.0	A
Peak Gate Power (Pulse Width $\leq 10 \mu\text{sec}$, $T_c = 108^\circ\text{C}$)	P_{GM}	2.0	W
Average Gate Power ($t = 8.3 \text{ msec}$, $T_c = 108^\circ\text{C}$)	$P_{G(AV)}$	1.0	W
Operating Junction Temperature Range	T_J	-40 to +125	$^\circ\text{C}$
Storage Temperature Range	T_{stg}	-40 to +150	$^\circ\text{C}$

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. V_{DRM} and V_{RRM} for all types can be applied on a continuous basis. Ratings apply for zero or negative gate voltage; however, positive gate voltage shall not be applied concurrent with negative potential on the anode. Blocking voltages shall not be tested with a constant current source such that the voltage ratings of the devices are exceeded.

Thermal Characteristics

Rating	Symbol	Value	Unit
Junction-to-Case (AC)	R_{eJC}	3.5	
Thermal Resistance, Junction-to-Ambient	R_{eJA}	88	$^\circ\text{C}/\text{W}$
Junction-to-Ambient (Note 2)	R_{eJA}	80	
Maximum Lead Temperature for Soldering Purposes, 1/8" from case for 10 seconds	T_L	260	$^\circ\text{C}$

2. These ratings are applicable when surface mounted on the minimum pad sizes recommended.

3. 1/8" from case for 10 seconds.

Electrical Characteristics - OFF ($T_J = 25^\circ\text{C}$ unless otherwise noted ; Electricals apply in both directions)

Characteristic	Symbol	Min	Typ	Max	Unit
Peak Repetitive Blocking Current ($V_D = V_{DRM} = V_{RRM}$; Gate Open)	$I_{DRM'}$ I_{RRM}	-	-	0.005 2.0	mA

Electrical Characteristics - ON ($T_J = 25^\circ\text{C}$ unless otherwise noted; Electricals apply in both directions)

Characteristic	Symbol	Min	Typ	Max	Unit
Peak On-State Voltage (Note 4) ($I_{TM} = \pm 6.0 \text{ A}$)	V_{TM}	-	1.3	1.6	V
Gate Trigger Current (Continuous dc) ($V_D = 12 \text{ V}$, $R_L = 100 \Omega$)	I_{GT}	8.0	12	35	mA
		8.0	18	35	
		8.0	22	35	
		-	-	-	
Holding Current ($V_D = 12 \text{ V}$, Gate Open, Initiating Current = $\pm 200 \text{ mA}$)	I_H	6.0	22	35	mA
Latching Current ($V_D = 12 \text{ V}$, $I_G = 35 \text{ mA}$)	I_L	-	30	60	mA
		-	50	80	
		-	20	60	
Gate Trigger Voltage (Continuous dc) ($V_D = 12 \text{ V}$, $R_L = 100 \Omega$)	V_{GT}	0.5	0.8	1.3	V
		0.5	0.8	1.3	
		0.5	0.8	1.3	
Gate Non-Trigger Voltage ($T_J = 125^\circ\text{C}$) ($V_D = 12 \text{ V}$, $R_L = 100 \Omega$)	V_{GD}	0.2	0.4	-	V
		0.2	0.4	-	
		0.2	0.4	-	

4. Indicates Pulse Test: Pulse Width $\leq 2.0 \text{ ms}$, Duty Cycle $\leq 2\%$.

Thyristors

Surface Mount – 600V - 800V > MAC4DCM, MAC4DCN

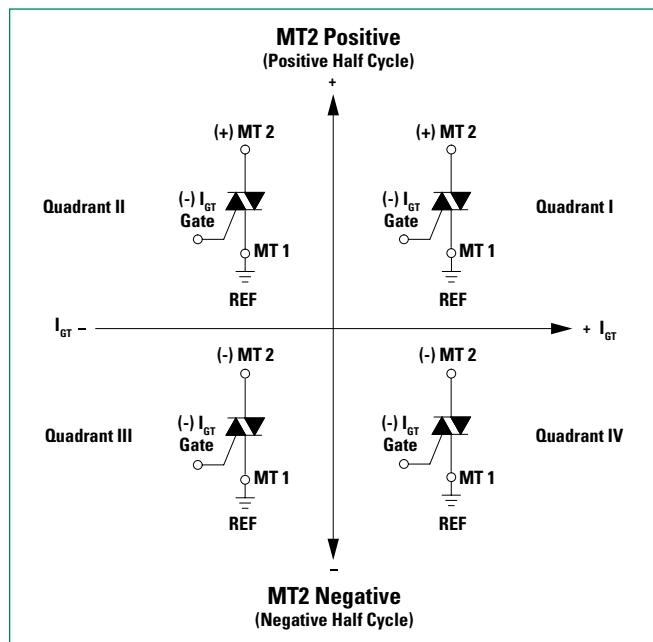
Dynamic Characteristics

Characteristic	Symbol	Min	Typ	Max	Unit
Rate of Change of Commutating Current ($V_D = 400$ V, $I_{TM} = 4.0$ A, Commutating $dv/dt = 18$ V/ μ sec, Gate Open, $T_J = 125^\circ\text{C}$, $f = 250$ Hz, $C_L = 5.0$ μ F, $LL = 20$ mH, No Snubber) (See Figure 16)	$(dl/dt)c$	6.0	8.4	—	A/ μ s
Critical Rate of Rise of Off-State Voltage ($V_D = 0.67 \times V_{DRM}$, Exponential Waveform, Gate Open, $T_J = 125^\circ\text{C}$)	dV/dt	500	1700	—	V/ μ s

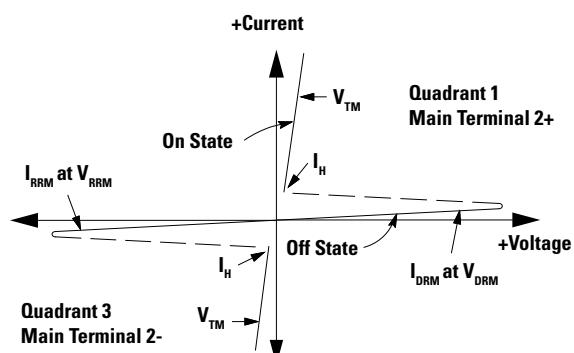
Voltage Current Characteristic of SCR

Symbol	Parameter
V_{DRM}	Peak Repetitive Forward Off State Voltage
I_{DRM}	Peak Forward Blocking Current
V_{RRM}	Peak Repetitive Reverse Off State Voltage
I_{RRM}	Peak Reverse Blocking Current
V_{TM}	Maximum On State Voltage
I_H	Holding Current

Quadrant Definitions for a Triac

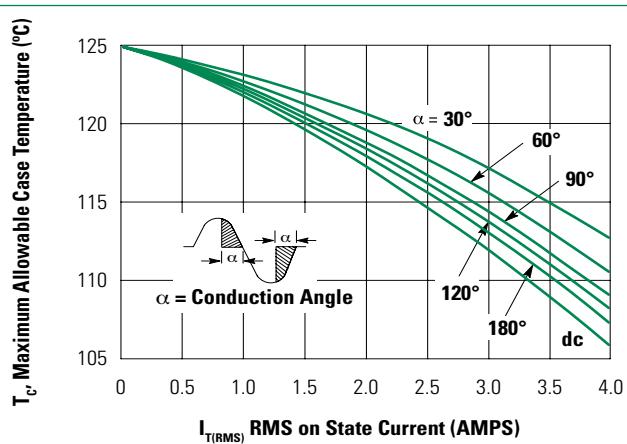
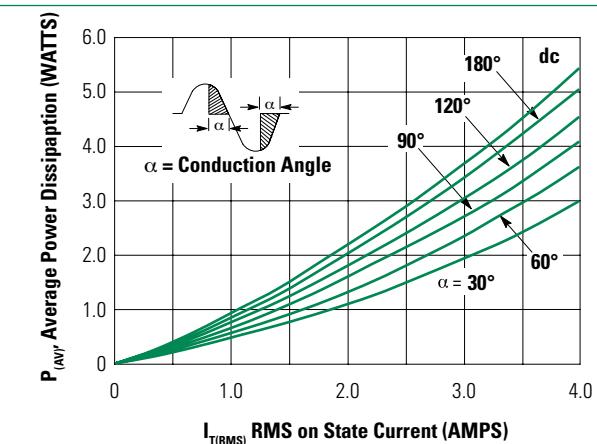
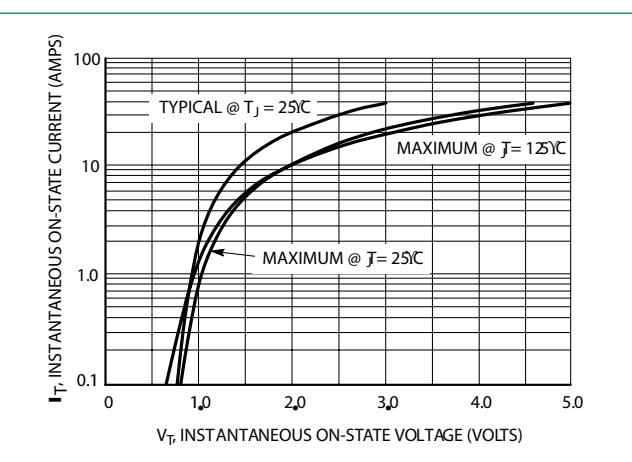
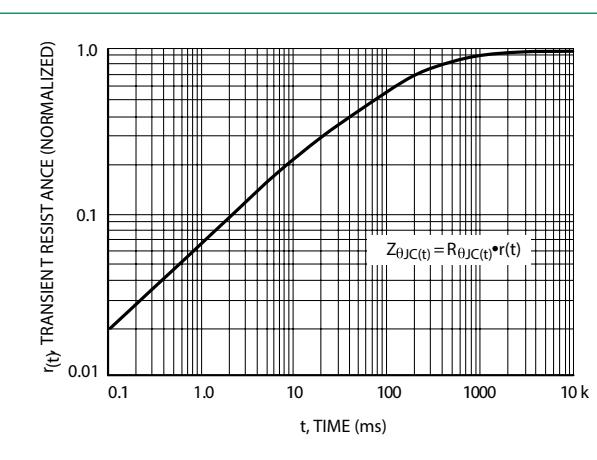
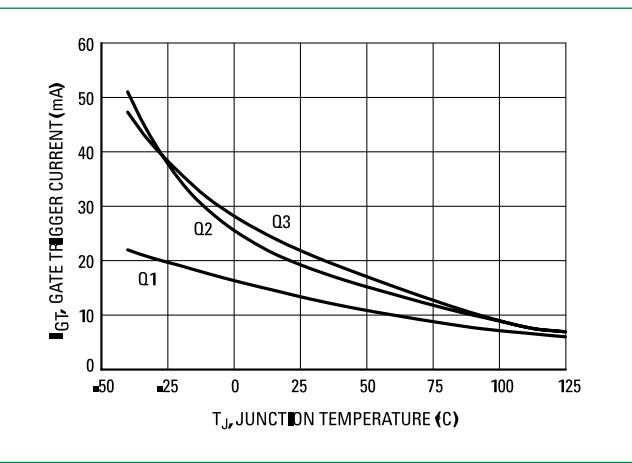
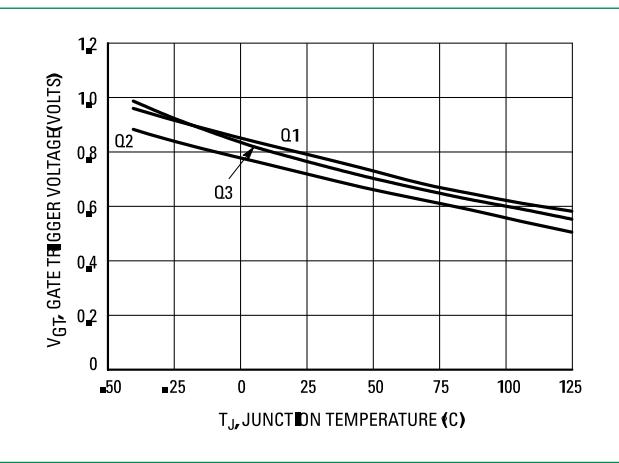


All Polarities are referenced to MT1.
With in-phase signals (using standard AC lines) quadrants I and III are used



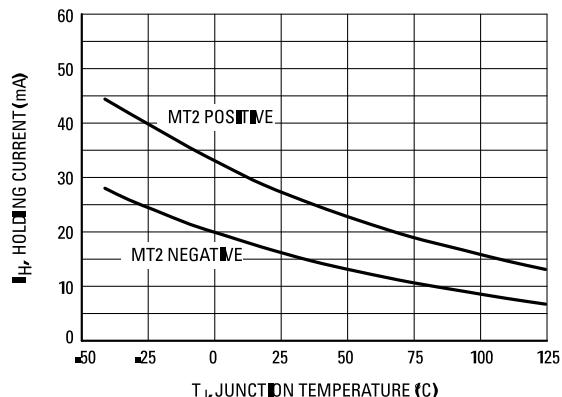
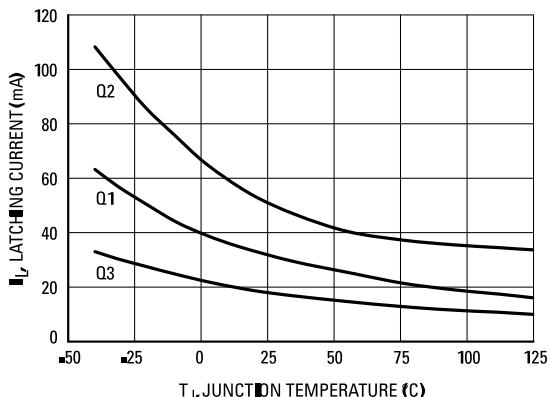
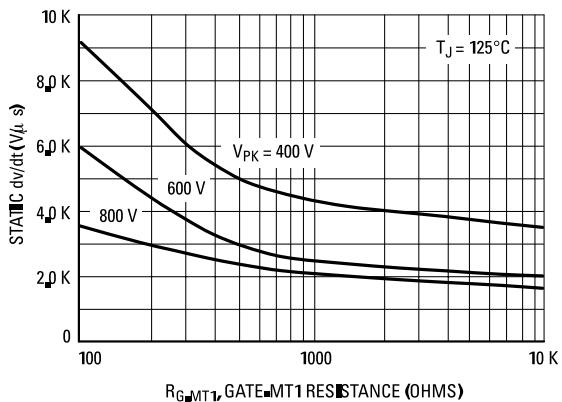
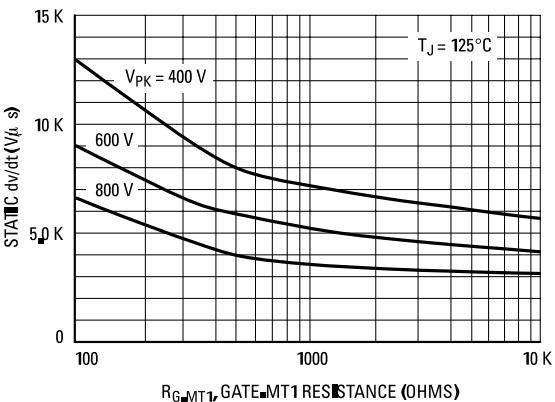
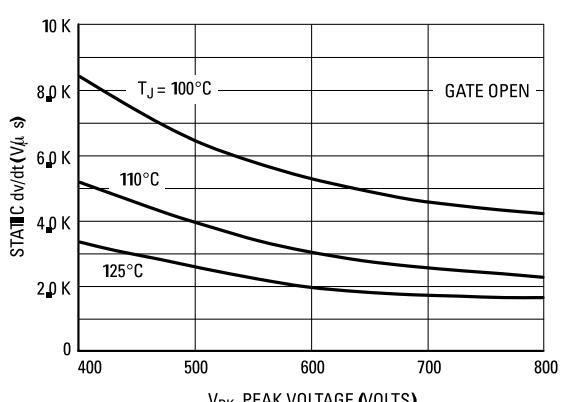
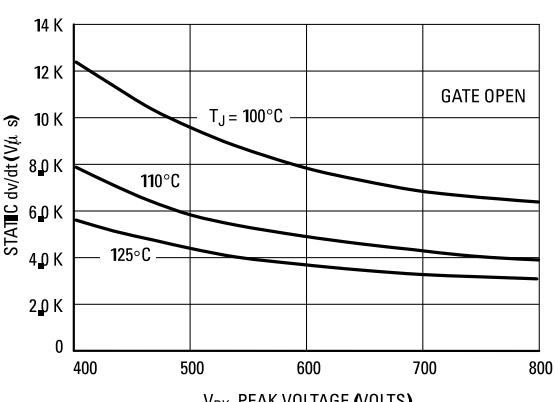
Thyristors

Surface Mount – 600V - 800V > MAC4DCM, MAC4DCN

Figure 1. Typical RMS Current Derating

Figure 2. On-State Power Dissipation

Figure 3. On-State Characteristics

Figure 4. Transient Thermal Response

Figure 5. Typical Gate Trigger Current vs. Junction Temperature

Figure 6. Typical Gate Trigger Voltage vs. Junction Temperature


Thyristors

Surface Mount – 600V - 800V > MAC4DCM, MAC4DCN

Figure 7. Typical Holding Current vs. Junction Temperature

Figure 8. Typical Latching Current vs. Junction Temperature

Figure 9. Exponential Static dv/dt vs. Gate-MT1 Resistance, MT2(+)

Figure 10. Exponential Static dv/dt vs. Gate-MT1 Resistance, MT2(-)

Figure 11. Exponential Static dv/dt vs. Peak Voltage, MT2(+)

Figure 12. Exponential Static dv/dt vs. Peak Voltage, MT2(-)


Thyristors

Surface Mount – 600V - 800V > MAC4DCM, MAC4DCN

Figure 13. Typical Exponential Static dv/dt vs.Junction Temperature, MT2(+)

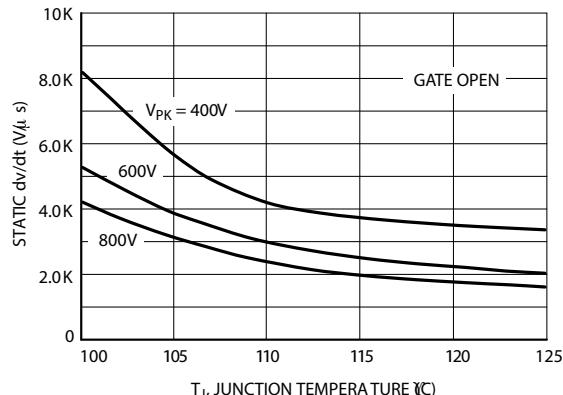


Figure 13. Typical Exponential Static dv/dt vs.Junction Temperature, MT2(-)

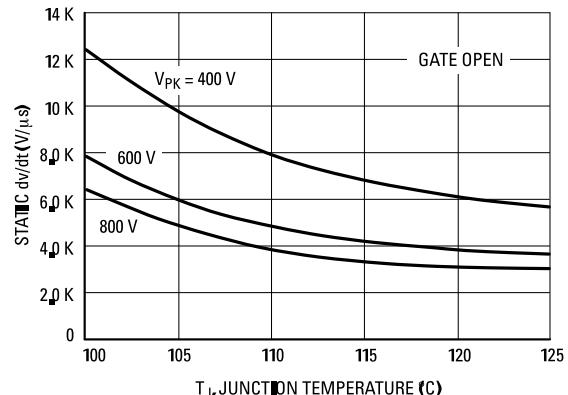


Figure 15. Critical Rate of Rise of Commutating Voltage

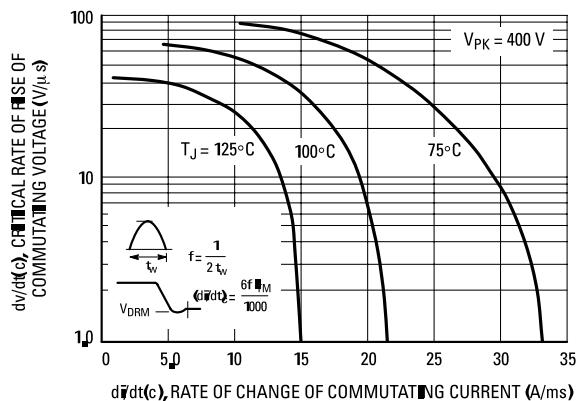
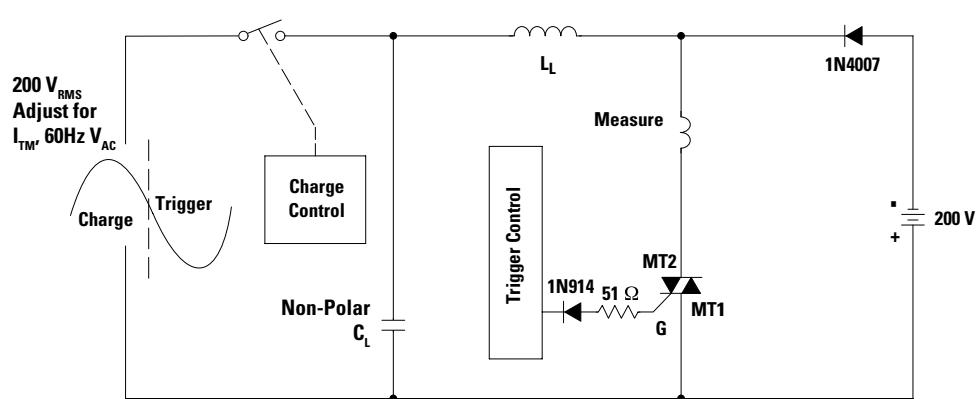
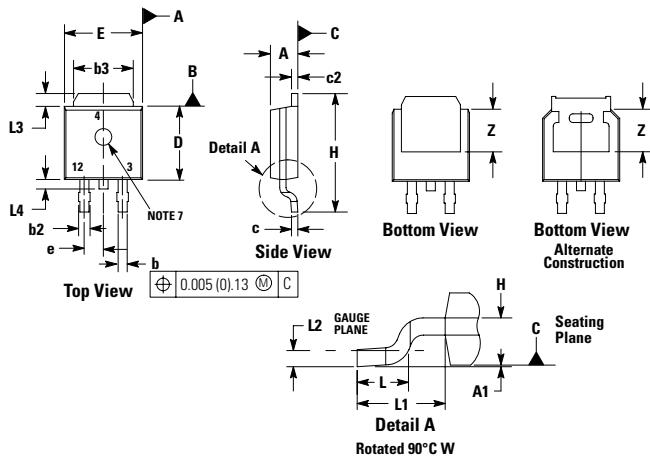


Figure 16. Simplified Test Circuit to Measure the Critical Rate of Rise of Commutating Current (di/dt)

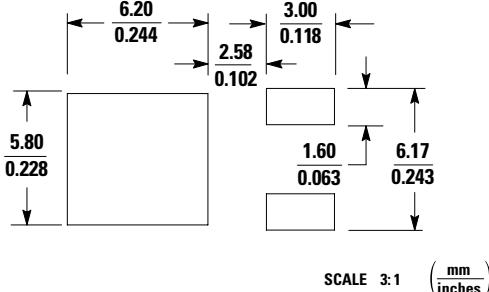


Note: Component values are for verification of rated (di/dt)c. See AN1048 for additional information

Dimensions



Soldering Footprint



SCALE 3:1 ($\frac{\text{mm}}{\text{inches}}$)

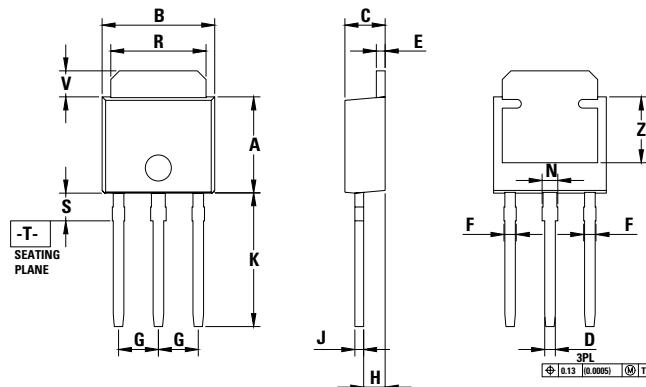
Dim	Inches		Millimeters	
	Min	Max	Min	Max
A	0.087	0.094	2.20	2.40
A1	0.000	0.005	0.00	0.12
b	0.022	0.030	0.55	0.75
b2	0.026	0.033	0.65	0.85
b3	0.209	0.217	5.30	5.50
c	0.019	0.023	0.49	0.59
c2	0.019	0.023	0.49	0.59
D	0.213	0.224	5.40	5.70
E	0.252	0.260	6.40	6.60
e	0.091		2.30	
H	0.374	0.406	9.50	10.30
L	0.058	0.070	1.47	1.78
L1	0.114		2.90	
L2	0.019	0.023	0.49	0.59
L3	0.053	0.065	1.35	1.65
L4	0.028	0.039	0.70	1.00
Z	0.154	-	3.90	-

Thyristors

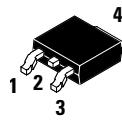
Surface Mount – 600V - 800V > MAC4DCM, MAC4DCN

Dimensions

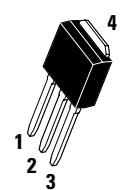
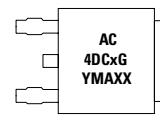
DPAK-3
Case 369D
T0251-3L POD



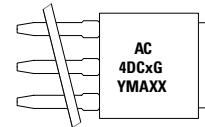
Part Marking System



DPAK-3
Case 369C
Style 6



DPAK-3
Case 369D
Style 6



AC4DCx =Device Code
x =D, M, or N
Y =Year
M =Month
A =Assembly Site
XX =Lot Serial Code
G =Pb-Free Package

Dim	Inches		Millimeters	
	Min	Max	Min	Max
A	0.213	0.224	5.40	5.70
B	0.252	0.260	6.40	6.60
C	0.087	0.094	2.20	2.40
D	0.024	0.030	0.60	0.75
E	0.022	0.026	0.55	0.65
F	0.022	0.03	0.58	0.78
G	0.091		2.30	
H	0.046	0.050	1.18	1.28
J	0.019	0.023	0.49	0.59
K	0.291	0.315	7.40	8.00
N	0.03	0.038	0.78	0.98
R	0.209	0.217	5.30	5.50
S	0.063		1.60	
V	0.053	0.065	1.35	1.65
Z	0.150		3.80	

1. Dimensioning and Tolerancing Per ANSI Y14.5M, 1982.

2. Controlling Dimension: Inch.

STYLE 6:Pin 1. MT1

2. MT2

3. Gate

4. MT2

Pin Assignment	
1	Main Terminal 1
2	Main Terminal 2
3	Gate
4	Main Terminal 2

Ordering Information

Device	Package Type	Package	Shipping
MAC4DCM-001	DPAK-3	369D	4000 Units / Box
MAC4DCM-1G	DPAK-3 (Pb-Free)	369D	4000 Units / Box
MAC4DCMT4	DPAK-3	369C	2500 / Tape & Reel
MAC4DCMT4G	DPAK-3 (Pb-Free)	369C	2500 / Tape & Reel
MAC4DCN-001	DPAK-3	369D	4000 Units / Box
MAC4DCN-1G	DPAK-3 (Pb-Free)	369D	4000 Units / Box
MAC4DCNT4	DPAK-3	369C	2500 / Tape & Reel
MAC4DCNT4G	DPAK-3 (Pb-Free)	369C	2500 / Tape & Reel

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